

Description

BACKGROUND OF THE INVENTION

The present invention relates to modular electrical connectors known as modular phone receptacles or jacks. More particularly, it relates to modular electrical connectors adapted for use in applications where height or space limitations render the use of conventional modular phone jacks mounted in accordance with conventional methods, unsuitable.

Modular electrical connectors known as modular phone receptacles or jacks have been known in the art for many years. Although connectors of this type were originally designed for the telecommunications industry, and in particular for telephones, these connectors have found wide acceptance other than for connecting a telephone to a telephone network. Another common use is as an input/output (I/O) interface with other communications peripheral equipment.

Mounted modular jacks are customarily used to serve as an interface between a standard modular plug and a printed circuit board. Modular phone jacks adapted to receive a conventional modular plug generally comprise a housing with a plug receiving socket formed therein. The socket is defined by a plug receiving opening, opposed top and bottom surfaces joined by opposed side surfaces extending from said opening to join a back surface. A plurality of stamped, metallic elongated conductors are mounted to the housing in some fashion. Each conductor includes a contact portion at one end extending diagonally into the socket, a lead portion at the other end and an intermediate portion between said contact portion and lead portion.

Modular phone jacks may comprise either one piece or two piece units. Illustrative one-piece units employing flat stamped metallic conductors are disclosed in United States Patent Nos. 4,292,736 and 4,315,664. Both of these patents disclose a one-piece dielectric housing having channels formed in the external surfaces thereof which are adapted to locate and hold the flat stamped conductors therein.

In United States Patent 4,457,570, a low profile modular phone jack of the one-piece type is disclosed, shown in Figures 10 or 11 therein. In accordance with this patent, space savings are achieved by removing the top wall of the connector housing of the modular jack and by inserting the housing into a cut out formed in the printed circuit board member. The low profile connector embodiments shown in Figures 10 and 11 of United States Patent 4,457,570 possess several shortcomings. For example, they require the use of a less conventional

or special order side-latch modular mating plug. Moreover, the printed circuit board must be provided with an additional rectangular cut out to receive the connector housing. The conductors are positioned in the connector manually and therefore these jacks cannot be manufactured by modern lower-cost fully automated methods.

Another low profile modular jack assembly of the one-piece type is described in United States Patent 4,497,526. In accordance with a low profile embodiment described in this patent, a printed circuit board is disposed within a housing, having upper and lower housing panels extending parallel to the circuit board. A one-piece modular jack is mounted on the circuit board and a cut out clearance notch is provided in the bottom wall of the jack and in the circuit board respectively.

An upstanding flange is provided which connects the upper and lower housing panels which includes a mating opening which communicates with the socket opening of the circuit board mounted jack. The opening in the flange is provided with a latching shoulder for co-operation with the latch member on the plug. Insertion of the plug member through the flange opening and into the socket permits the latch on the plug to be retained by the retaining means formed by the combination of the latching shoulders in the flange opening and the cut out portions formed in the bottom wall of the jack member and the circuit board.

The structure depicted in United States Patent 4,497,526 has several disadvantages. It requires the use of additional panels to house the circuit board. In mother-daughter arrangements, the structure still would not provide a low profile modular jack which could be used on a plurality of closely spaced parallel circuit boards. The reason for this is that whatever height above the circuit board is eliminated, is added below the circuit board by the added housing members needed to form the latching means. This structure would merely interfere with corresponding jacks on an adjacent board in a parallel closely-spaced circuit board array such as a mother-daughter arrangement.

In addition to the one-piece modular jack assemblies described above, two-piece modular jacks are known. Typically, two-piece modular phone jack assemblies include a connector housing having a forward end with a plug receiving opening therein, two opposed side walls, the internal surfaces thereof defining socket side surfaces, a top wall joining said side walls and a rearward end with a rear opening formed therein. A carrier subassembly is mounted through the rear opening of the housing. The subassembly has a dielectric support member to which the conductors are mounted and means are provided which co-operate between the housing and the subassembly to lock the sub-

assembly to the housing.

A two-piece modular phone jack is described in United States Patent 4,618,207 comprising a carrier subassembly for the conductors comprising a support member including a body portion, a horizontal base portion extending rearwardly of the body portion and a generally horizontal cantilevered top portion extending forwardly of the body portion. The conductors are positioned and staked onto the upper surface of the top portion of the support member so that simultaneous forming and positioning of said conductors can occur during the manufacturing process. The two-piece jack disclosed in United States Patent 4,618,207 provides a modular jack of good mechanical strength and integrity which can be made by fully automated methods in an extremely low cost manufacturing process. Although the jack provides distinct advantages over other prior art two-piece or one-piece assemblies, still lower profile modifications of the one and two-piece type are desired or required for many modern applications.

An object of the present invention is to provide a low profile modular electrical connector which may be used to connect printed circuit board members to other components in close-spacing environments where prior art modular jack connectors, primarily because of their heights, cannot be used.

According to the present invention there is provided such a connector including housing means having a forward mating end, a rearward end and a modular plug-receiving socket formed therein, said socket being defined by a plug-receiving opening formed in the forward mating end with a lower latch-receiving region, opposed top and bottom surfaces joined by opposed side surfaces extending from said plug-receiving opening to join a back surface within said housing; a plurality of metallic elongated conductors mounted to said housing, each conductor including a contact portion at one end extending from said forward end diagonally into the socket, a lead portion at the other end and an intermediate portion between said contact portion and lead portion; and means for attaching said housing means to an uncut portion of a printed circuit board to define said socket whereby the upper surface of a printed circuit board disposed generally below said housing means forms the bottom surface of the socket; said forward mating end of said housing means then extending beyond an edge of the printed circuit board with said forward mating end being offset downwardly relative to the remaining portion of the housing means so that the lower latch-receiving region of the plug-receiving opening is below the upper surface of the printed circuit board, characterised in that the lowermost extension of said forward mating end is positioned to be flush with the plane of the

opposed lower surface of the printed circuit board.

A modular jack assembly of the present invention accomplishes a lower profile by providing a housing means which includes a forward extension of the jack at the forward mating end that includes the plug-receiving opening and the lower latch-receiving region which is downwardly offset so that the latch-receiving region is below the upper surface of the circuit board. In addition, the forward mating end wraps around or overhangs the edge, so that e.g. the lower exterior surface of the mating end is aligned with the bottom surface of the circuit board, i.e. the mating end is also flush mounted relative to the underside of the board. Moreover, the housing means employs the upper surface of the circuit board to define the bottom surface of the plug-receiving socket, thereby eliminating the need for an added bottom wall in the housing means provided in the prior art housings.

The dropped, over-the-edge forward mating end which provides the plug-receiving opening and the latch retaining feature, together with the absence of a bottom housing wall, advantageously combine to significantly reduce the overall height of the jack assembly in such manner that a modular plug/jack connector of the invention may be used in closely-spaced applications previously foreclosed to plug/jack style connectors.

Some ways of carrying out the present invention will now be described in detail by way of example with reference to drawings which show specific embodiments of the present invention:

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 is a perspective view of a low profile right angle modular phone jack of this invention in use, mounted on a printed circuit board which is disposed in closely-spaced relation to an adjacent parallel panel, and showing a mateable latch down modular plug used with the jack;

FIG. 2 is an exploded perspective view of the jack and plug;

FIG. 3 is a side elevational view in cross section of the housing means of the jack;

FIG. 4 is a side elevational view in cross section of the jack prior to mounting on a circuit board, and showing the plug;

FIG. 5 is an exploded perspective view of the jack taken from the rear thereof;

FIG. 6 is a top plan view of a group of metal conductors of the jack shown attached at both ends to a carrier strip;

FIG. 7 is a top plan view of a support member comprising a part of the jack;

FIG. 8 is an elevational side view of the support member showing the group of conductors illustrated in Fig. 6 initially mounted at the top

thereof; and

FIG. 9 is an elevational side view of the support member illustrating succeeding steps in the manufacturing process.

DETAILED DESCRIPTION OF THE ILLUSTRATED EMBODIMENTS

Referring to Fig. 1, the jack, generally designated by reference numeral 10, is shown in its intended use, being mounted on a printed circuit board 12 which is located adjacent a closely spaced parallel panel 14. The clearance between adjacent surfaces of the printed circuit board 12 and parallel panel 14 is designated as the distance h. Parallel panel 14 is intended to represent an adjacent printed circuit board, as in a closely spaced-parallel array of daughter boards in a mother-daughter arrangement, or may represent a panel of a component housing enclosing the printed circuit board. In either case, the jack 10 is intended for use in environments wherein the spacing distance h is less than one inch, more particularly less than about 0.8 inch, and even as low as about 0.6 inch.

Broadly, the jack 10 includes a housing member 16 enclosing and defining a plug receiving socket 18. Housing member 16 includes forward mating end 20 having a plug receiving opening 22 and a lower latch receiving region 24 located therein. Forward mating end 20 extends beyond the edge 26 of circuit board 12 and is disposed downwardly relative to the central and rearward portion of housing means 16, such that the lower latch receiving region 24 of forward mating end 20 is below the upper surface 28 of circuit board 12.

The jack assembly 10 is adapted to receive and mate with a standard latch-down modular phone plug 30. Modular plug 30 generally includes a plug housing 32 having a plurality of terminals 34 therein. The terminals 34 are adapted to electrically connect conductors disposed in socket 18 at one end thereof to conductors (not shown) extending within the plug cord or cable 36 at the other end. A manually actuated flexible lower latch 38 is formed on the plug housing 32 to lock and remove the plug 30 from jack assembly 10.

Fig. 1 generally illustrates the housing means 16 with its downwardly offset forward mating end 20 disposed beyond edge 26 so that the lower latch-receiving region 24 in plug receiving opening 22 is below the upper surface 28 of printed circuit board 12. In addition, the lower exterior surface, i.e. the lowermost extension of mating end 20 is flush mounted with respect to the underside surface of printed circuit board 12. Furthermore, as will be described hereinafter, housing means 16 co-operates with printed circuit board 12 to define plug-

receiving socket 18, whereby upper surface 28 of circuit board 12 is the bottom surface of socket 18. The housing means 16 provides a reduction in the height of the overall jack arrangement without adding height or additional structures below the bottom surface of the circuit board. More particularly, in the arrangement now being described, approximately 0.2 inch of verticle height is eliminated between the surface 28 of circuit board 12 and the jack housing 16. The modular jack arrangement being described permits input/output modular jacks to be mounted on several adjacent parallel daughter boards wherein the application requires that the daughter boards be spaced less than about 0.8 inch, or even as low as about 0.6 inch, apart.

More particularly, a referring now to Figs. 2 to 5, a two-piece low profile modular phone jack arrangement including circuit board 12, housing means 16 and a carrier subassembly 76 is shown. Low profile jack 10 firstly comprises a three-sided housing means 16 defined by two opposed sidewalls 40, 42 and top wall 44 having a downwardly offset forward mating end 20 and a rearward end 46 having a rearward opening 48 defined therein.

Forward mating end 20 includes plug-receiving opening 22 and lower latch-receiving region 24. Surrounding opening 22 are forward extensions 40a and 42a of opposed sidewalls 40 and 42, respectively, as well as forward top wall extension 44a of top wall 44. The internal surfaces 50 and 52 defined by sidewalls 40 and 40a and sidewall 42 and 42a, respectively, and internal surface 54 defined by top walls 44 and 44a together define side and top surfaces of plug receiving socket 18 disposed in housing means 16.

Opposed from top wall extension 44a is lower latch-receiving region 24 which is defined by a lower lip 56 joining sidewall extensions 40a and 42a in forward mating end 20. Lower lip 56 includes upstanding plug guide members 58, 58 disposed adjacent to and abutting sidewall extensions 40a and 42a, respectively. Immediately adjacent plug guide members 58 are the latching shoulders 60, 60 which are connected by a latch-receiving trough portion 62 in lower lip 56. Latching shoulders 60 are adapted to engage extensions 64, 64 on lower latch 38 of modular plug 30 as shown in Fig. 4, to retain plug 30 in mating relationship with jack 10. As shown in the drawings, the interior side surfaces 50, 52 and top surface, as well as the upper surfaces of guide members 58 and latching shoulders 60, are all tapered inwardly from opening 22 into socket 18 to define a flared entry to socket 18 to facilitate insertion and removal of mating plug 30.

As shown in Figs. 1 and 2, sidewall 40 is provided with a vertical locating rib 71 which to-

gether with a corresponding vertical locating rib 71 disposed on sidewall 42 (not shown) is adapted to engage the surface of panel immediately adjacent an opening through which jack assembly 10 is received (also not shown) to provide a flush mount with a mating face of housing 16, if desired.

Sidewalls 40 and 42 are also provided with depending semi-cylindrical mounting bosses 66, 66 respectively, which are received in mounting apertures 68, 68 in printed circuit board 12 to secure housing means 16 thereto. At the rearward end 46 of the housing means 16 sidewalls 40 and 42 are each equipped with a three-sided projection comprising shrouding portions 70, 70 respectively, which define the rear opening 48 in rearward end 46.

As best shown in Figs. 3 and 5, interior surfaces 50 and 52 are provided with guide channels 72, 72 formed in shrouded portions 70. Guide channels 72 extend forwardly to apertures 74, 74 extending through each sidewall 40 and 42 which serve to inter-engage with a portion of a carrier subassembly 76 to be more particularly described immediately hereafter.

Also shown in Fig. 5 a comb structure 78 extends between interior surfaces 50 and 52 adjacent rearward end 46, which is adapted to cooperate with metallic conductors 80 in a manner which will be described more particularly hereafter.

Turning now to the carrier subassembly 76 shown in Figs. 2 and 5 to 9, subassembly 76 comprises a dielectric support member 82. Support member 82 comprises a vertical body portion 84 having a rearwardly extending horizontal base portion 86 and a forwardly extending cantilevered top conductor mounting portion 88. The forwardly facing surface 90 of body portion 84 defines the aforementioned back surface of socket 18. The body portion 84 also has a pair of side panel portions 92.

Top mounting portion 88 of support member 82 has an upper surface 94 with a plurality of upstanding staggered locating projections 96. The front end on the top portion 88 has a front edge 98 with a plurality of conductor locating fins 100 formed thereat. The conductors 80 are mounted on the upper surface 94 of the top portion 88, so that a portion thereof extends from the front edge 98 to the rear edge 102.

A pair of side locking wings 104, 104 are provided on the top portion 88. Locking wings 104 are receivable within guide channels 72 and interengage into apertures 74 when the carrier subassembly 76 is mounted to housing means 16.

Base portion 86 has a rearwardly extending staggered conductor receiving structure 106 as best shown in Figs. 5 and 7 with restricted conductor receiving slots 108 formed therein. Each slot

108 has a tapered guide or thread portion 110 formed rearwardly thereof in order to guide a portion of a conductor 80 therein as shown in Fig. 7.

Extending laterally of the base portion 86 are a pair of standoff block portions 112, 112. Block portions 112 underlie the shrouded portions 70 of the housing means 16 and comprise a rearward extension of sidewalls 40 and 42 when carrier subassembly 76 is mounted within housing 16.

Referring now to Figs. 5 and 6, each conductor 80 generally includes a contact portion 114 and lead portion 116 and an intermediate portion 118 therebetween. The intermediate portion 118 of each conductor 80 has a pair of spaced apart pilot holes 120 formed therein.

The pilot holes 120 of adjacent conductors are staggered with respect to one another as shown in Fig. 6. Locating projections 96 are adapted to be received within the pilot holes 120 so as to position the conductors 80 on the top surface 94 of top portion 88 of support member 82.

Each conductor 80 also includes a stop shoulder 122 formed on the lead portion 116 thereof. Stop shoulder 122 engages the bottom of the contact receiving structure 106 so as to prevent accidental removal of the lead portions 116 due to an upwardly directed push out force when the carrier subassembly 76 is mounted within the housing 16. After insertion of the subassembly 76 into housing 16 the inwardly directed contact portions 114 of conductors 80 are positioned and held apart by the comb structure 78 extending along the back wall.

When jack 10 is assembled and mounted onto circuit board 12 it meets all the required specifications and has all the necessary dimensions to receive a standard modular phone plug 30 with a significantly reduced overall height.

The jack 10 can be manufactured in a low-cost fully automatable process, generally illustrated in Figures 6 to 9.

The method comprises producing a housing means 16 of the type defined above including the three-sided member having a forward mating end 20 including a plug-receiving opening 22 and a latch-retaining region 24 which is downwardly offset relative to the three-sided member as an integral unitary molded part; producing the support member 82 as an integral unitary molded part; stamping a group 124 of conductors 80 with carrier strips 126 and staggered pilot holes 120 from conductive sheet metal stock; mounting the group 124 of conductors 80 onto the upper surface 94 of top portion 88 of support member 82 so that upstanding projections 96 are received within pilot holes 120 and securing them by staking over projections 96; removing the carrier strips 126 and deforming mounted conductors 80 first downwardly and then inwardly to form the diagonally rearwardly directed

contact portions 114, and downwardly directed lead portions 116; securing the lead portions 116 onto base member 86 by positioning the lead portion 116 into the contact receiving structure 106 such that the stop shoulders 122 on the lead portions engage the bottom surface of contact receiving structure 106 and respective receiving slots 108 to prevent accidental removal of lead portions 116 due to an upwardly directed pushout force; and thereafter, mounting carrier subassembly 76 through rearward opening 48 of housing member 16 by slidably engaging wings 104 into guide channels 72 until wings 104 snap into retained position within apertures 74 on housing means 16 and conductor contact portions 114 are received in comb structure 78.

The assembled jack 10 is finally edge mounted by placing mounting bosses 66 into mounting apertures 68 on the circuit board and simultaneously positioning lead portions 116 on conductors 80 into footprint apertures 128 placed within circuit board 12 and thereafter electrically connecting the leads 116 to the electrical circuit by, for example, soldering the leads into the footprint apertures 128.

For a more detailed description of the method for making the carrier subassembly, reference should be made to United States Patent 4,618,207.

Although the invention has been described with reference to a two piece-jack, it should be readily apparent to those skilled in this art that housing 16 could be molded to accommodate a one-piece modular phone jack arrangement. Accordingly, in the molding step for a one-piece jack housing, the structure of forward mating end 20 containing the plug receiving opening 22 and the lower latch receiving region 24 should be molded to be offset and displaced downwardly relative to the remaining portions of the housing 16, so that when the one-piece jack assembly is mounted on a printed circuit board the forward mating end will also overhang the edge of the printed circuit board in a similar fashion. In addition, the housing in a one-piece design should be molded to define a socket member which also utilizes the upper surface 28 of circuit board as the bottom surface of the socket.

As is apparent from the above description given with reference to the drawings, a low profile modular phone jack is provided by modifying the housing member to include a downwardly offset forward mating end and by modifying the socket defining structures of the housing member to cooperate with the circuit board such that the bottom surface of the socket is defined by the upper surface of the circuit board, to eliminate unnecessary height. The unitary molded structure of the housing member provides excellent plug retention capability and excellent mechanical strength.

Claims

1. A low profile modular electrical connector (10) which may be used to connect a printed circuit board (12) member to another component including:

housing means (16) having a forward mating end (20), a rearward end (46) and a modular plug-receiving socket (18) being defined by a plug-receiving opening (22) formed in the forward mating end with a lower latch-receiving region (24), opposed top (44) and bottom surfaces joined by opposed side surfaces (40,42) extending from said plug-receiving opening to join a back surface within said housing;

a plurality of metallic elongated conductors (80) mounted to said housing, each conductor including a contact portion (114) at one end extending from said forward end diagonally into the socket, a lead portion (116) at the other end and an intermediate portion (118) between said contact portion and lead portion; and

said forward mating end (20) of said housing means then extending beyond an edge (26) of the printed circuit board (12) with said forward mating end being offset downwardly relative to the remaining portion of the housing means so that the lower latch-receiving region (24) of the plug-receiving opening is below the upper surface (28) of the printed circuit board, characterised in that

means (66) is provided for attaching said housing means to an uncut portion of a printed circuit board to define said socket whereby the upper surface of a printed circuit board disposed generally below said housing means forms the bottom surface of the socket; and the lowermost extension of said forward mating end is positioned to be flush with the plane of the opposed lower surface of the printed circuit board.

2. A connector as claimed in claim 1 wherein said forward mating end (20) further comprises opposed extensions (40a, 42a) from each of said opposed sidewalls and a lower lip member (56) joining said opposed sidewall extensions, said lower lip member including the lower latch receiving region (24) defined therein on the upper surface thereof.
3. A connector as claimed in claim 2, wherein said forward mating end further includes an opposed top wall extension joining said side wall extensions.
4. A connector as claimed in claim 4 wherein the

contact portions 114, and downwardly directed lead portions 116; securing the lead portions 116 onto base member 86 by positioning the lead portion 116 into the contact receiving structure 106 such that the stop shoulders 122 on the lead portions engage the bottom surface of contact receiving structure 106 and respective receiving slots 108 to prevent accidental removal of lead portions 116 due to an upwardly directed pushout force; and thereafter, mounting carrier subassembly 76 through rearward opening 48 of housing member 16 by slidably engaging wings 104 into guide channels 72 until wings 104 snap into retained position within apertures 74 on housing means 16 and conductor contact portions 114 are received in comb structure 78.

The assembled jack 10 is finally edge mounted by placing mounting bosses 66 into mounting apertures 68 on the circuit board and simultaneously positioning lead portions 116 on conductors 80 into footprint apertures 128 placed within circuit board 12 and thereafter electrically connecting the leads 116 to the electrical circuit by, for example, soldering the leads into the footprint apertures 128.

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As is apparent from the above description given with reference to the drawings, a low profile modular phone jack is provided by modifying the housing member to include a downwardly offset forward mating end and by modifying the socket defining structures of the housing member to cooperate with the circuit board such that the bottom surface of the socket is defined by the upper surface of the circuit board, to eliminate unnecessary height. The unitary molded structure of the housing member provides excellent plug retention capability and excellent mechanical strength.

Claims

1. A low profile modular electrical connector (10) which may be used to connect a printed circuit board (12) member to another component including:

housing means (16) having a forward mating end (20), a rearward end (46) and a modular plug-receiving socket (18) being defined by a plug-receiving opening (22) formed in the forward mating end with a lower latch-receiving region (24), opposed top (44) and bottom surfaces joined by opposed side surfaces (40,42) extending from said plug-receiving opening to join a back surface within said housing;

a plurality of metallic elongated conductors (80) mounted to said housing, each conductor including a contact portion (114) at one end extending from said forward end diagonally into the socket, a lead portion (116) at the other end and an intermediate portion (118) between said contact portion and lead portion; and

said forward mating end (20) of said housing means then extending beyond an edge (26) of the printed circuit board (12) with said forward mating end being offset downwardly relative to the remaining portion of the housing means so that the lower latch-receiving region (24) of the plug-receiving opening is below the upper surface (28) of the printed circuit board, characterised in that

means (66) is provided for attaching said housing means to an uncut portion of a printed circuit board to define said socket whereby the upper surface of a printed circuit board disposed generally below said housing means forms the bottom surface of the socket; and the lowermost extension of said forward mating end is positioned to be flush with the plane of the opposed lower surface of the printed circuit board.

2. A connector as claimed in claim 1 wherein said forward mating end (20) further comprises opposed extensions (40a, 42a) from each of said opposed sidewalls and a lower lip member (56) joining said opposed sidewall extensions, said lower lip member including the lower latch receiving region (24) defined therein on the upper surface thereof.
3. A connector as claimed in claim 2, wherein said forward mating end further includes an opposed top wall extension joining said side wall extensions.
4. A connector as claimed in claim 4 wherein the



inner surfaces of said lower lip, said top wall extension, and each of said opposed sidewall extensions are tapered inwardly to define a flared entrance extending from said plug-receiving opening into said plug-receiving socket.

5. A connector as claimed in claim 2, 3 or 4 wherein said lower latch receiving region includes a plurality of latching shoulders (60) disposed on the upper surface of said lower lip member at a point intermediate the length of said lower lip member, said latching shoulders being positioned for co-operation with complementary latching extensions included on a latch down modular plug. 5 10 15
6. A method of manufacturing a connector as claimed in any preceding claim comprising producing housing means (16), said housing means including a three sided member having a forward mating end (20) including a plug-receiving opening (22) and a latch-retaining region (24) which is downwardly offset relative to the three sided member, producing a support member (82), stamping a group (124) of conductors (80) with carrier strips (126) and staggered pilot holes (120) from conductive sheet metal stock, mounting the group of conductors (80) onto the upper surface (94) of a top portion (88) of the support member (82) so that upstanding projections (96) of the support member are received within the pilot holes (120) and securing them by staking over projections (96), removing the carrier strips (126) and deforming the mounted conductors (80) first downwardly and then inwardly to form said diagonally rearwardly directed contact portions (114) and downwardly directed lead portions (116), securing the lead portions (116) onto a base (86) of said support member (82) by positioning each lead portion into contact receiving structure (106) of the support member such that a stop shoulder (122) on the lead portion engages the bottom surface of the contact receiving structure (106) and a respective receiving slot (108) to prevent accidental removal of the lead portion and thereafter mounting the carrier subassembly (76) through a rearward opening (48) of the housing means (16) by slidingly engaging wings (104) on the subassembly into guide channels (72) of the housing means (16) until the wings (104) snap into retained position within apertures (74) on the housing means (16) and the conductor contact portions (114) are received in a comb structure (78) of the housing means. 20 25 30 35 40 45 50 55

Patentansprüche

1. Elektrischer Flachform-Modulverbinder (10), der zum Verbinden eines Elements einer gedruckten Leiterplatte (12) mit einem anderen Bauteil verwendet werden kann, bestehend aus: einem Gehäuse (16) mit einem vorderen Verbindungsende (20), einem hinteren Ende (46) und einer einen Modulstecker aufnehmenden Steckdose (18), die begrenzt ist von einer im vorderen Verbindungsende gebildeten Steckeraufnahmeöffnung (22) mit einer unteren Klinkenaufnahmezone (24), einer Oberseite (44) und einer Unterseite, die einander gegenüberliegen und durch einander gegenüberliegende Seitenflächen (40,42) verbunden sind, die von der Steckeraufnahmeöffnung ausgehen, um sich mit einer hinteren Fläche im Gehäuse zu verbinden, und einer Mehrzahl im Gehäuse angebrachter metallischer langgestreckter Leiter (80), wobei jeder Leiter einen von dem vorderen Ende sich diagonal in die Steckdose erstreckenden Kontaktbereich (114) an einem Ende, einen Leiterbereich (116) an dem anderen Ende und einen Zwischenbereich (118) zwischen dem Kontaktbereich und dem Leiterbereich aufweist, wobei das vordere Verbindungsende (20) des Gehäuses unterhalb eines Randes (26) der gedruckten Leiterplatte (12) verläuft, mit nach unten in bezug auf den verbleibenden Bereich des Gehäuses versetztem vorderem Verbindungsende, derart, daß die untere Klinkenaufnahmezone (24) der Steckeraufnahmeöffnung unterhalb der oberen Oberfläche (28) der gedruckten Leiterplatte liegt, dadurch gekennzeichnet, daß eine Einrichtung (66) zum Anbringen des Gehäuses an einem ungeschnittenen Bereich einer gedruckten Leiterplatte zur Bildung der Steckdose vorgesehen ist, wodurch die obere Oberfläche einer gedruckten Leiterplatte, die im allgemeinen unterhalb des Gehäuses angeordnet ist, die untere Oberfläche der Steckdose bildet, und die untere Verlängerung des vorderen Verbindungsendes eine solche Position hat, daß sie bündig mit der Ebene der gegenüberliegenden unteren Oberfläche der gedruckten Leiterplatte verläuft. 5 10 15 20 25 30 35 40 45 50
2. Verbinder nach Anspruch 1, bei dem das vordere Verbindungsende (20) ferner einander gegenüberliegende Verlängerungen (40a,42a) von jeder der einander gegenüberliegenden Seitenwände und ein die gegenüberliegenden Seitenwandverlängerungen verbindendes unteres Lippenelement (56) umfaßt, wobei das untere Lippenelement die untere Klinkenaufnahmezone (24) aufweist, die in diesem auf 55



dessen oberer Oberfläche gebildet ist.

3. Verbinder nach Anspruch 2, bei dem das vordere Verbindungsende ferner eine gegenüberliegende, die Seitenwandverlängerungen verbindende Oberwandverlängerung aufweist. 5
4. Verbinder nach Anspruch 3, bei dem die inneren Oberflächen der unteren Lippe, die Oberwandverlängerung und jede der einander gegenüberliegenden Seitenwandverlängerungen nach innen verjüngt sind, derart, daß ein erweiterter Eingang gebildet ist, der sich von der Steckeraufnahmeöffnung in die den Stecker aufnehmende Steckdose erstreckt. 10
5. Verbinder nach Anspruch 2, 3 oder 4, bei dem die untere Klinkenaufnahmezone eine Mehrzahl von Rastschultern (60) aufweist, die auf der oberen Oberfläche des unteren Lippenelements an einem Zwischenpunkt auf der Länge des unteren Lippenelements angeordnet sind, wobei die Rastschultern eine Position für ein Zusammenwirken mit komplementären Rastansätzen an einem nach unten einrastenden Modulstecker aufweisen. 20
6. Verfahren zum Herstellen eines Verbinders nach einem beliebigen vorhergehenden Anspruch, darin bestehend, daß ein Gehäuse (16) hergestellt wird, wobei das Gehäuse ein dreiseitiges Element mit einem eine Steckeraufnahmeöffnung (22) aufweisenden vorderen Verbindungsende (20) und einer Klinkenhaltezone (24) aufweist, die nach unten in bezug auf das dreiseitige Element versetzt ist, ein Stützteil (82) hergestellt wird, eine Gruppe (124) von Leitern (80) mit Trägerstreifen (126) und versetzten Führungslöchern (120) aus einem leitenden Elechvorrat gestanzt wird, die Gruppe von Leitern (80) auf der oberen Oberfläche (94) eines oberen Bereichs (88) des Stützteils (82) montiert wird, so daß hochstehende Vorsprünge (96) des Stützteils in den Führungslöchern (120) aufgenommen und sie durch Durchstecken von Vorsprüngen (96) festgelegt werden, die Trägerstreifen (126) weggenommen und die montierten Leiter (80) zuerst nach unten und dann nach innen verformt werden, um die diagonal rückwärts gerichteten Kontaktbereiche (114) und die nach unten gerichteten Leiterbereiche (116) zu bilden, die Leiterbereiche (116) auf einer Basis (86) des Stützteils (82) festgelegt werden, indem jeder Führungsbereich in eine Kontaktaufnahmeausbildung (106) des Stützteils verbracht wird, derart, daß eine Anschlagschulter (122) am Leiterbereich mit der bodenseitigen 30

Oberfläche der Kontaktaufnahmeausbildung (106) und einem jeweiligen Aufnahmeschlitz (108) zur Verhinderung einer zufälligen Entnahme des Leiterbereichs in Eingriff kommt, und danach die Trägeruntereinheit (76) durch eine rückwärtige Öffnung (48) des Gehäuses (16) durch Gleiteingriff von Flügeln (104) an der Untereinheit in Führungskanäle (72) des Gehäuses (16) hineinmontiert wird, bis die Flügel (104) in eine Halteposition in Öffnungen (74) am Gehäuse (16) einrasten und die Leiterkontaktbereiche (114) in einer Kammausbildung (78) des Gehäuses aufgenommen sind.

15 Revendications

1. Connecteur électrique modulaire (10) à profil bas, qui peut être utilisé pour connecter une carte de circuit imprimé (12) à un autre composant, comportant un boîtier (16) ayant une extrémité antérieure d'accouplement (20), une extrémité postérieure (46) et un logement modulaire (18) de réception d'une fiche, lequel est défini par une ouverture (22) de réception d'une fiche, formée dans l'extrémité antérieure d'accouplement avec une région inférieure (24) de réception d'un verrou, des surfaces opposées supérieure (44) et inférieure reliées par des surfaces latérales opposées (40,42) s'étendant à partir de l'ouverture de réception d'une fiche pour rejoindre une surface arrière dans le boîtier, une pluralité de conducteurs métalliques allongés (80) montés dans le boîtier, chaque conducteur comportant, à une extrémité, une partie de contact (114) s'étendant à partir de l'extrémité antérieure en diagonale vers et dans le logement, une partie de sortie (116) à l'autre extrémité et une partie intermédiaire (118) entre la partie de contact et la partie de sortie, l'extrémité antérieure d'accouplement (20) du boîtier s'étendant au-delà d'un bord (26) de la carte de circuit imprimé (12), cette extrémité antérieure d'accouplement étant décalée vers le bas par rapport à la partie restante du boîtier de telle façon que la région inférieure (24), de réception du verrou, de l'ouverture de réception d'une fiche se trouve en dessous de la surface supérieure (28) de la carte de circuit imprimé, caractérisé en ce qu'un moyen (66) est prévu pour attacher le boîtier à une partie non découpée d'une carte de circuit imprimé, afin de définir le logement de telle façon que la surface supérieure de la carte de circuit imprimé qui est disposée d'une manière générale en dessous du boîtier, forme la surface inférieure du logement et l'extension la plus basse de l'extrémité antérieure d'accouplement est disposée de manière à se 40



trouver à fleur avec le plan de la surface inférieure opposée de la carte de circuit imprimé.

2. Connecteur suivant la revendication 1 caracté-
risé en ce que l'extrémité antérieure d'accou-
plement (20) comprend en outre des prolonge-
ments opposés (40a,42a) à partir de chacune
des parois latérales opposées et une lèvre
inférieure (56) reliant ces prolongements oppo-
sés des parois latérales, cette lèvre inférieure
comportant la région inférieure (24) de récep-
tion d'un verrou laquelle est définie sur la
surface supérieure de cette lèvre. 5
3. Connecteur suivant la revendication 2 caracté-
risé en ce que l'extrémité antérieure d'accou-
plement comporte en outre un prolongement
opposé de la paroi supérieure reliant les pro-
longements des parois latérales. 10
4. Connecteur suivant la revendication 3 caracté-
risé en ce que les surfaces internes de la lèvre
inférieure, du prolongement de la paroi supé-
rieure et de chacun des prolongements oppo-
sés des parois latérales sont convergentes
vers l'intérieur de manière à définir une entrée
évasée s'étendant à partir de l'ouverture de
réception d'une fiche, vers et dans le logement
de réception d'une fiche. 15
5. Connecteur suivant la revendication 2,3 ou 4
caractérisé en ce que la région inférieure de
réception d'un verrou comporte une pluralité
d'épaulements de verrouillage (60) disposés
sur la surface supérieure de la lèvre inférieure,
en un point intermédiaire sur la longueur de
cette (60) disposés sur la surface supérieure
de la lèvre inférieure, en un point intermédiaire
sur la longueur de cette lèvre inférieure, ces
épaulements de verrouillage étant disposés de
manière à coopérer avec des saillies de ver-
rouillage complémentaires incluses sur une fi-
che modulaire à verrou s'étendant vers le bas. 20
6. Procédé de fabrication d'un connecteur suivant
l'une quelconque des revendications précéden-
tes caractérisé en ce qu'on produit un boîtier
(16) comportant un élément à trois côtés ayant
une extrémité antérieure d'accouplement (20),
comportant une ouverture (22) de réception
d'une fiche et une région (24) de retenue d'un
verrou qui est décalée vers le bas par rapport
à l'élément à trois côtés, on produit un élé-
ment support (82), on estampe un groupe
(124) de conducteurs (80) avec des bandes
support (126) et des trous pilotes (120) déca-
lés en quinconce, à partir d'une ébauche en 25

feuillard métallique conducteur, on monte le
groupe de conducteurs (80) sur la surface su-
périeure (94) d'une partie supérieure (88) de
l'élément support (82), de telle façon que des
saillies vers le haut (96) de l'élément support
viennent se loger dans les trous pilotes (120)
et assurent leurs fixations par refoulement des
saillies (96), on enlève les bandes support
(126) et on déforme les conducteurs (80) tout
d'abord vers le bas puis vers l'intérieur, afin de
former les parties de contact (114) dirigées en
diagonale vers l'arrière et les parties de sortie
(116) dirigées vers le bas, à fixer les parties de
sortie (116) sur une base (86) du support (82),
en plaçant chaque partie de sortie dans la
structure (106) de réception des contacts du
support de telle façon qu'un épaulement d'ar-
rêt (122) présent sur la partie de sortie vienne
en contact avec la surface inférieure de la
structure (106) de réception des contacts et
avec une fente de réception respective (108),
afin d'empêcher une extraction accidentelle de
la partie de sortie, et à monter après cela le
sous-ensemble porteur (76) à travers une ou-
verture postérieure (48) du boîtier (16), en en-
gageant à glissement des ailes (104) prévues
sur le sous-ensemble dans des canaux de
guidage (72) du boîtier (16), jusqu'à ce que les
ailes (104) viennent s'encliqueter, en position
retenue, dans des ouvertures (74) prévues
dans le boîtier (16), et que les parties de
contact (114) des conducteurs viennent se lo-
ger dans une structure en forme de peigne
(78) du boîtier. 30

